

TOSHIBA Photocoupler GaA As Ired & Photo IC

# 6N135, 6N136

Digital Logic Isolation. Line Receiver. Power Supply Control Switching Power Supply **Transistor Inverter** 

UL recognized: UL1577, file no. E67349 ٠



Weight: 0.54 g (typ.)

#### **Pin Configurations**



- 1 : N.C. 2 : ANODE 3 : CATHODE
- 4 : N.C.
- 5 : EMITTER
- 6 : COLLECTOR 7 : BASE, ANODE
- 8 : CATHODE



Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit	
LED	Forward current	(Note 1)	lF	25	mA	
	Pulse forward current	(Note 2)	I <sub>FP</sub>	50	mA	
	Total pulse forward current	(Note 3)	I <sub>FPT</sub>	1	А	
	Reverse voltage		V <sub>R</sub>	5	V	
	Diode power dissipation	(Note 4)	PD	45	mW	
Detector	Output current		Ι <sub>Ο</sub>	8	mA	
	Peak output current		I <sub>OP</sub>	16	mA	
	Emitter-base reverse voltage (p	V <sub>EB</sub>	5	V		
	Supply voltage		V <sub>CC</sub>	-0.5~15	V	
	Output voltage		VO	-0.5~15	V	
	Base current (pin 7)		Ι <sub>Β</sub>	5	mA	
	Output power dissipation	(Note 5)	Po	100	mW	
Operating temperature range			T <sub>opr</sub>	-55~100	°C	
Storag	orage temperature range		T <sub>stg</sub>	-55~125	°C	
Lead	solder temperature (10s)	(Note 6)	T <sub>sol</sub>	260	°C	
Isolati	on voltage	(Note 7)	BV <sub>S</sub> 2500		V <sub>rms</sub>	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- (Note 1) Derate 0.8mA above 70°C.
- (Note 2) 50% duty cycle, 1ms pulse width. Derate 1.6mA / °C above 70°C.
- (Note 3) Pulse width 1 $\mu$ s, 300pps.
- (Note 4) Derate 0.9mW / °C above 70°C.
- (Note 5) Derate 2mW / °C above 70°C.
- (Note 6) Soldering portion of lead: Up to 2mm from the body of the device.
- (Note 7) R.H. 60%, AC / 1min.

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# Switching Specifications (unless otherwise specified. Ta = $25^{\circ}$ C, V<sub>CC</sub> = 5V, I<sub>F</sub> = 16mA)

Characteristic		Symbol	Test Circuit	Test Condition	Min.	Тур.	Max.	Unit
Propagation delay	6N135	<b>*</b>	1	R <sub>L</sub> = 4.1k		0.2	1.5	μs
at output	6N136	чрНL	I	R <sub>L</sub> = 1.9k		0.2	0.8	μs

### Test Circuit 1.





(\*)  $C_L$  is approximately 15<sub>P</sub>F which includes probe and stray wiring capacitance.

#### Test Circuit 2.



Forward current IF (mA)





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